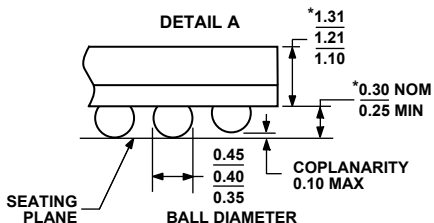
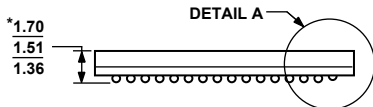
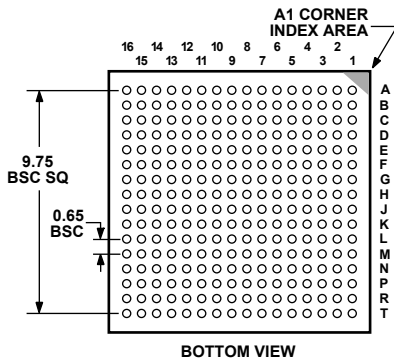
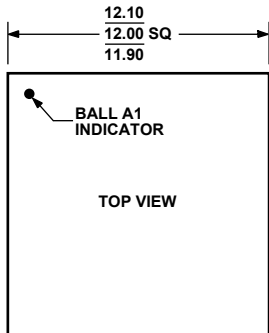


**256-Lead Chip Scale Package Ball Grid Array [CSP_BGA]
(BC-256-1)**

Dimensions shown in millimeters



*COMPLIANT TO JEDEC STANDARDS MO-225 WITH EXCEPTION
TO DIMENSIONS INDICATED BY AN ASTERISK.